ACKNOWLEDGEMENT RECEIPT

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Title of **Electroless Plating Method** Invention

Submision Type: Information Disclosure

Statement

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First Named Applicant: Kei MURAYAMA

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File Listing:

Doc. Name	File Name	Size (Bytes)	Date
		1	Produced
			(yyyymmdd)
us-ids	i040170-usidst.xml		2005-02-16
us-ids	us-ids.dtd	7763	2005-02-16
us-ids	us-ids.xsl	12026	2005-02-16
package-data	i040170-pkda.xml	1683	2005-02-16
package-data	package-data.dtd	27025	2005-02-16
package-data	us-package-data.xsl	19263	2005-02-16
	Total files size	68944	

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